



60V N-CHANNEL ENHANCEMENT MODE MOSFET POWERDI

Product Summary

BV _{DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
00)/	$13m\Omega$ @ $V_{GS} = 10V$	10.3A
60V	$18m\Omega @ V_{GS} = 4.5V$	8.8A

Description and Applications

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Motor Control
- DC to DC Converters
- Reverse Polarity Protection

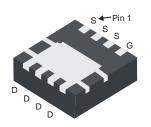
Features and Benefits

- Low R_{DS(ON)} ensures on state losses are minimized
- Small form factor thermally efficient package enables higher density end products
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: PowerDI3333-8
- Case Material: Molded Plastic, "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.072 grams (Approximate)

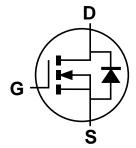
PowerDI3333-8







Top View



Equivalent Circuit

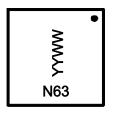
Ordering Information (Note 5)

Part Number	Case	Packaging
DMN6013LFGQ-7	PowerDI3333-8	2,000/Tape & Reel
DMN6013LFGQ-13	PowerDI3333-8	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



N63 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 16 = 2016) WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Drain-Source Voltage	V _{DSS}	60	V	
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Dusin Courset (Note 7) // 40)/	$T_A = +25$ °C $T_A = +70$ °C	Ι _D	10.3 8.3	А
Continuous Drain Current (Note 7) V _{GS} = 10V	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	l _D	45 28	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I _{DM}	58.3	Α	
Maximum Continuous Body Diode Forward Current (Note 7)		I _S	3	Α
Avalanche Current, L = 0.1mH		I _{AS}	33.3	Α
Avalanche Energy, L = 0.1mH		E _{AS}	56.8	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Total Power Dissipation (Note 6)		P_D	1	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	р.:	123	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t < 10s	$R_{\theta JA}$	69	
Total Power Dissipation (Note 7)		P_D	2.1	W
Thermal Resistance, Junction to Ambient (Note 7)	Steady state	р	60	°C/W
Thermal Resistance, Junction to Ambient (Note 7)	t < 10s	$R_{\theta JA}$	34	
Total Power Dissipation (Note 7)		P_D	40	W
Thermal Resistance, Junction to Case (Note 7)		$R_{\theta JC}$	6.7	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	$V_{GS} = 0V$, $I_D = 250\mu A$	
Zero Gate Voltage Drain Current, T _J = +25°C	I _{DSS}	_	_	1	μA	$V_{DS} = 60V, V_{GS} = 0V$	
Gate-Source Leakage		_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	1	1.8	3	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	В	_	9.3	13	mΩ	$V_{GS} = 10V, I_D = 10A$	
Static Drain-Source On-Resistance	R _{DS(ON)}		12.3	18		$V_{GS} = 4.5V, I_D = 8A$	
Diode Forward Voltage	V_{SD}	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1.7A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	1	2577	_	pF	.,	
Output Capacitance	Coss	_	162	_	pF	$V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz	
Reverse Transfer Capacitance	C _{rss}	_	132	_	pF	-1 = 11VIH2	
Gate Resistance	Rg	_	0.9	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	26.6	_	nC	V _{DS} = 30V, I _D = 10A	
Total Gate Charge (V _{GS} = 10V)	Qg	_	55.4	_	nC		
Gate-Source Charge	Q _{gs}	_	9.3	_	nC		
Gate-Drain Charge	Q _{gd}	_	12.6	_	nC		
Turn-On Delay Time	t _{D(ON)}		6.2	_	ns		
Turn-On Rise Time	t _R		9.9	_	ns	$V_{GS} = 10V, V_{DS} = 30V,$ $R_G = 3\Omega, I_D = 10A$	
Turn-Off Delay Time	t _{D(OFF)}		27.6	_	ns		
Turn-Off Fall Time	t _F		11.7	_	ns		
Body Diode Reverse Recovery Time	t _{RR}		9.4	_	ns	1 400 41/44 4000///-	
Body Diode Reverse Recovery Charge	Q_{RR}	I	18.6		nC	$I_F = 10A$, di/dt = 100A/ μ s	

Notes: 6. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

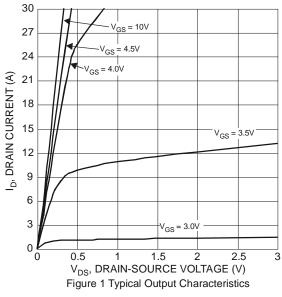
^{7.} Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

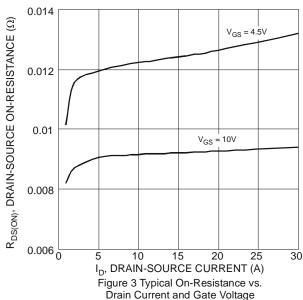
^{8.} Short duration pulse test used to minimize self-heating effect.

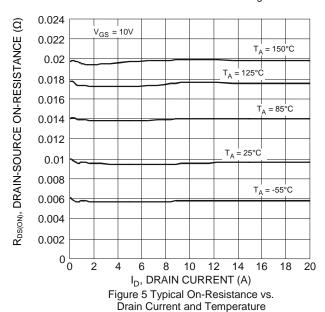
^{9.} Guaranteed by design. Not subject to product testing.



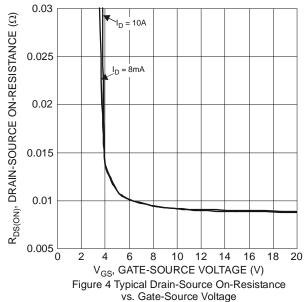








30 $V_{DS} = 5.0V$ 25 ID, DRAIN CURRENT (A) 20 15 10 T_A = 150 °C 5 = 25°C -55°C 0 1.5 2 2.5 4.5 5 V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 2 Typical Transfer Characteristics



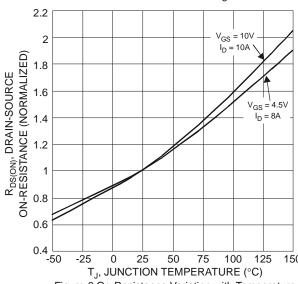
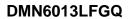
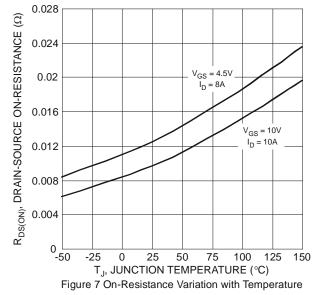


Figure 6 On-Resistance Variation with Temperature







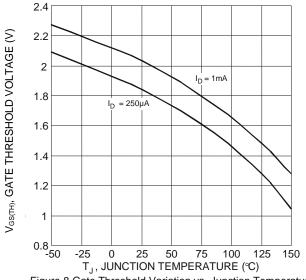
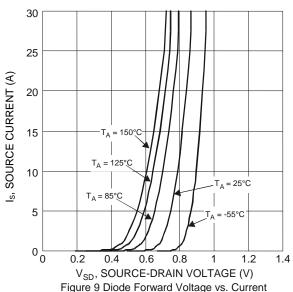
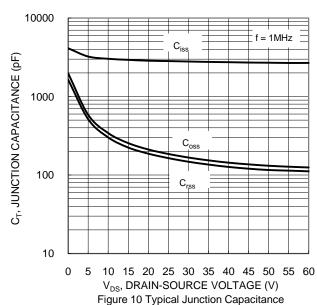
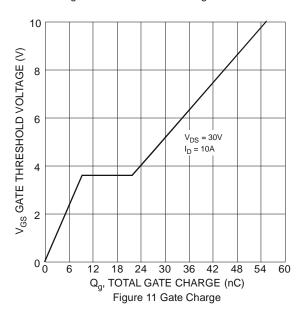
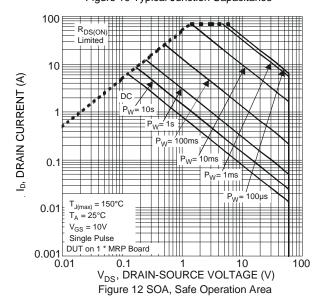


Figure 8 Gate Threshold Variation vs. Junction Temperature

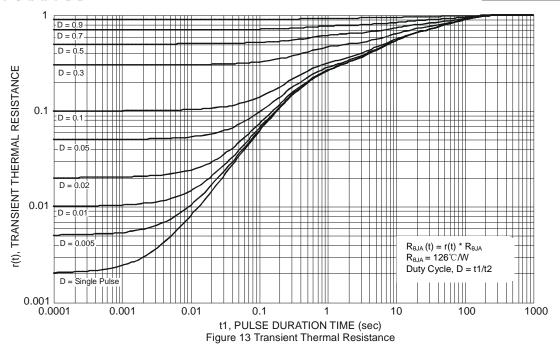










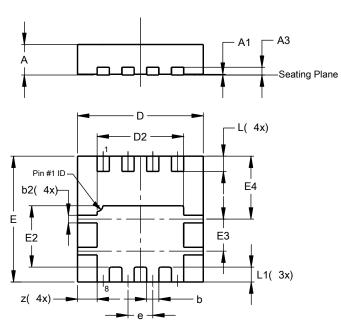




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8

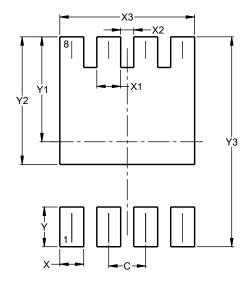


PowerDI3333-8						
Dim	Min Max		Тур			
Α	0.75	0.85	0.80			
A1	0.00	0.05	0.02			
А3	ı	-	0.203			
b	0.27	0.37	0.32			
b2	0.15	0.25	0.20			
D	3.25	3.35	3.30			
D2	2.22	2.32	2.27			
Е	3.25	3.35	3.30			
E2	1.56	1.66	1.61			
E3	0.79	0.89	0.84			
E4	1.60	1.70	1.65			
е	_	_	0.65			
L	0.35	0.45	0.40			
ī	_	_	0.39			
z	_	_	0.515			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	Value (in mm)
С	0.650
X	0.420
X1	0.420
X2	0.230
Х3	2.370
Y	0.700
Y1	1.850
Y2	2.250
Y3	3 700



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